

SMD Comm COG Flex, Ceramic, 4700 pF, 5%, 100 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812



Dimensions

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
T	1mm +/-0.10mm
B	0.7mm +/-0.35mm

Packaging Specifications

Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information

Series:	SMD Comm COG Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Ultra-Stable
Features:	FT-CAP, Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	67 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	4700 pF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	100 VDC
Dielectric Withstanding Voltage:	250 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms

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